## BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu$ PC8182TB

## 3 V, 2.9 GHz SILICON MMIC MEDIUM OUTPUT POWER AMPLIFIER FOR MOBILE COMMUNICATIONS

## DESCRIPTION

The $\mu \mathrm{PC} 8182 \mathrm{~TB}$ is a silicon monolithic integrated circuit designed as amplifier for mobile communications. This IC operates at 3 V . The medium output power is suitable for RF-TX of mobile communications system.

This IC is manufactured using our $30 \mathrm{GHz} \mathrm{f}_{\max }$ UHSO (Ultra High Speed Process) silicon bipolar process. This process uses direct silicon nitride passivation film and gold electrodes. These materials can protect the chip surface from pollution and prevent corrosion/migration. Thus, this IC has excellent performance, uniformity and reliability.

## FEATURES

- Supply voltage: Vcc = 2.7 to 3.3 V
- Circuit current: Icc = 30 mA TYP. @ Vcc $=3.0 \mathrm{~V}$
- Medium output power: $\mathrm{Po}_{(1 \mathrm{~dB})}=+9.5 \mathrm{dBm}$ TYP. @ $\mathrm{f}=0.9 \mathrm{GHz}$

$$
\begin{aligned}
& \mathrm{Po}(1 \mathrm{~dB})=+9.0 \mathrm{dBm} \text { TYP. @ } \mathrm{f}=1.9 \mathrm{GHz} \\
& \mathrm{Po}(1 \mathrm{~dB})=+8.0 \mathrm{dBm} \text { TYP. @ } \mathrm{f}=2.4 \mathrm{GHz}
\end{aligned}
$$

- Power gain: $\mathrm{Gp}=21.5 \mathrm{~dB}$ TYP. @ $\mathrm{f}=0.9 \mathrm{GHz}$

$$
\begin{aligned}
& \mathrm{Gp}=20.5 \mathrm{~dB} \text { TYP. @ } \mathrm{f}=1.9 \mathrm{GHz} \\
& \mathrm{Gp}=20.5 \mathrm{~dB} \text { TYP. } @ \mathrm{f}=2.4 \mathrm{GHz}
\end{aligned}
$$

- Upper limit operating frequency: fu = 2.9 GHz TYP. @ 3 dB bandwidth
- High-density surface mounting: 6-pin super minimold package ( $2.0 \times 1.25 \times 0.9 \mathrm{~mm}$ )


## APPLICAION

- Buffer amplifiers on 1.9 to 2.4 GHz mobile communications system


## ORDERING INFORMATION (Solder Contains Lead)

| Part Number | Package | Marking | Supplying Form |
| :---: | :---: | :---: | :--- |
| $\mu$ PC8182TB-E3 | 6-pin super minimold | C3F | •Embossed tape 8 mm wide |
|  |  |  | • Pin 1, 2, 3 face the perforation side of the tape <br>  <br>  |
|  |  | Qty $3 \mathrm{kpcs} /$ reel |  |

Remark To order evaluation samples, contact you're nearby sales office. Part number for sample order: $\mu$ PC8182TB

## ORDERING INFORMATION (Pb-Free)

| Part Number | Package | Marking | Supplying Form |
| :---: | :---: | :---: | :--- |
| $\mu$ PC8182TB-E3-AZ* | 6-pin super minimold | C3F | •Embossed tape 8 mm wide <br>  |
|  |  | Pin 1, 2, 3 face the perforation side of the tape <br>  <br>  |  |

*NOTE: Please refer to the last page of this data sheet, "Compliance with EU Directives" for Pb-Free RoHS Compliance Information.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

## PIN CONNECTIONS



PRODUCT LINE-UP ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{Vcc}=\mathrm{V}_{\mathrm{out}}=3.0 \mathrm{~V}, \mathrm{Zs}=\mathrm{ZL}=50 \Omega$ )

| Part No. | $\begin{gathered} \mathrm{fu} \\ (\mathrm{GHz}) \end{gathered}$ | Po (1dB) <br> (dBm) | Gp <br> (dB) | $\begin{aligned} & \text { Icc } \\ & (\mathrm{mA}) \end{aligned}$ | Package | Marking |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mu \mathrm{PC} 8182 \mathrm{BB}$ | 2.9 | $\begin{aligned} & +9.5 @ \mathrm{f}=0.9 \mathrm{GHz} \\ & +9.0 @ \mathrm{f}=1.9 \mathrm{GHz} \\ & +8.0 @ \mathrm{f}=2.4 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & 21.5 @ \mathrm{f}=0.9 \mathrm{GHz} \\ & 20.5 @ \mathrm{f}=1.9 \mathrm{GHz} \\ & 20.5 @ \mathrm{f}=2.4 \mathrm{GHz} \end{aligned}$ | 30.0 | 6-pin super minimold | C3F |
| $\mu \mathrm{PC} 2762 \mathrm{~T}$ | 2.9 | $\begin{aligned} & +8.0 @ \mathrm{f}=0.9 \mathrm{GHz} \\ & +7.0 @ \mathrm{f}=1.9 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & 13.0 @ \mathrm{f}=0.9 \mathrm{GHz} \\ & 15.5 @ \mathrm{f}=1.9 \mathrm{GHz} \end{aligned}$ | 26.5 | 6-pin minimold | C1Z |
| $\mu \mathrm{PC} 2762$ TB |  |  |  |  | 6-pin super minimold |  |
| $\mu \mathrm{PC} 2763 \mathrm{~T}$ | 2.7 | $\begin{aligned} & +9.5 @ \mathrm{f}=0.9 \mathrm{GHz} \\ & +6.5 @ \mathrm{f}=1.9 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & 20.0 @ \mathrm{f}=0.9 \mathrm{GHz} \\ & 21.0 @ \mathrm{f}=1.9 \mathrm{GHz} \end{aligned}$ | 27.0 | 6-pin minimold | C2A |
| $\mu \mathrm{PC} 2763$ TB |  |  |  |  | 6-pin super minimold |  |
| $\mu \mathrm{PC} 2771 \mathrm{~T}$ | 2.2 | $\begin{aligned} & +11.5 @ \mathrm{f}=0.9 \mathrm{GHz} \\ & +9.5 @ \mathrm{f}=1.5 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & 21.0 @ \mathrm{f}=0.9 \mathrm{GHz} \\ & 21.0 @ \mathrm{f}=1.5 \mathrm{GHz} \end{aligned}$ | 36.0 | 6-pin minimold | C 2 H |
| $\mu \mathrm{PC} 2771 \mathrm{BB}$ |  |  |  |  | 6-pin super minimold |  |
| $\mu \mathrm{PC8181}{ }^{\text {P }}$ | 4.0 | $\begin{aligned} & +8.0 @ \mathrm{f}=0.9 \mathrm{GHz} \\ & +7.0 @ \mathrm{f}=1.9 \mathrm{GHz} \\ & +7.0 @ \mathrm{f}=2.4 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & 19.0 @ \mathrm{f}=0.9 \mathrm{GHz} \\ & 21.0 @ \mathrm{f}=1.9 \mathrm{GHz} \\ & 22.0 @ \mathrm{f}=2.4 \mathrm{GHz} \end{aligned}$ | 23.0 | 6-pin super minimold | C3E |

Remark Typical performance. Please refer to ELECTRICAL CHARACTERISTICS in detail.
Caution The package size distinguishes between minimold and super minimold.

## SYSTEM APPLICATION EXAMPLE

Digital cellular telephone


Caution The insertion point is different due to the specifications of conjunct devices.

PIN EXPLANATION


Note Pin voltage is measured at $\mathrm{Vcc}=3.0 \mathrm{~V}$.

## ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Test Conditions | Ratings | Unit |
| :--- | :---: | :--- | :---: | :---: |
| Supply Voltage | $\mathrm{Vcc}_{\mathrm{cc}}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, pin 4 and pin 6 | 3.6 | V |
| Total Circuit Current | Icc | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | Note | 60 |
| Power Dissipation | $\mathrm{PD}_{\mathrm{D}}$ | $\mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$ | 270 | mA |
| Operating Ambient Temperature | $\mathrm{T}_{\mathrm{A}}$ |  | -40 to +85 | mW |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ |  | -55 to +150 | ${ }^{\circ}{ }^{\circ} \mathrm{C}$ |
| Input Power | Pin | $\mathrm{TA}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | +10 | dBm |

Note Mounted on double-sided copper-clad $50 \times 50 \times 1.6 \mathrm{~mm}$ epoxy glass PWB

## RECOMMENDED OPERATING RANGE

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit | Remarks |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage | $\mathrm{Vcc}^{\prime}$ | 2.7 | 3.0 | 3.3 | V | Same voltage should be applied <br> to pin 4 and pin 6. |
| Operating Ambient Temperature | $\mathrm{T}_{\mathrm{A}}$ | -40 | +25 | +85 | ${ }^{\circ} \mathrm{C}$ | - |

## ELECTRICAL CHARACTERISTICS

$\left(\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{Vcc}=\mathrm{V}_{\mathrm{out}}=3.0 \mathrm{~V}, \mathrm{Zs}=\mathrm{Z} \mathrm{L}=50 \Omega\right.$, unless otherwise specified)

| Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Circuit Current | Icc | No signal | - | 30.0 | 38.0 | mA |
| Power Gain | Gp | $\begin{aligned} & \mathrm{f}=0.9 \mathrm{GHz} \\ & \mathrm{f}=1.9 \mathrm{GHz} \\ & \mathrm{f}=2.4 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & 19.0 \\ & 18.0 \\ & 18.0 \end{aligned}$ | $\begin{aligned} & 21.5 \\ & 20.5 \\ & 20.5 \end{aligned}$ | $\begin{aligned} & 25.0 \\ & 24.0 \\ & 24.0 \end{aligned}$ | dB |
| Noise Figure | NF | $\begin{aligned} & \mathrm{f}=0.9 \mathrm{GHz} \\ & \mathrm{f}=1.9 \mathrm{GHz} \\ & \mathrm{f}=2.4 \mathrm{GHz} \end{aligned}$ |  | $\begin{aligned} & 4.5 \\ & 4.5 \\ & 5.0 \end{aligned}$ | $\begin{aligned} & 6.0 \\ & 6.0 \\ & 6.5 \end{aligned}$ | dB |
| Upper Limit Operating Frequency | fu | 3 dB down below from gain at $\mathrm{f}=0.1 \mathrm{GHz}$ | 2.6 | 2.9 | - | GHz |
| Isolation | ISL | $\begin{aligned} & \mathrm{f}=0.9 \mathrm{GHz} \\ & \mathrm{f}=1.9 \mathrm{GHz} \\ & \mathrm{f}=2.4 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & 28 \\ & 27 \\ & 26 \end{aligned}$ | $\begin{aligned} & 33 \\ & 32 \\ & 31 \end{aligned}$ |  | dB |
| Input Return Loss | RLin | $\begin{aligned} & \mathrm{f}=0.9 \mathrm{GHz} \\ & \mathrm{f}=1.9 \mathrm{GHz} \\ & \mathrm{f}=2.4 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & 5 \\ & 7 \\ & 9 \end{aligned}$ | $\begin{gathered} 8 \\ 10 \\ 12 \end{gathered}$ |  | dB |
| Output Return Loss | RLout | $\begin{aligned} & \mathrm{f}=0.9 \mathrm{GHz} \\ & \mathrm{f}=1.9 \mathrm{GHz} \\ & \mathrm{f}=2.4 \mathrm{GHz} \end{aligned}$ | $\begin{gathered} 7 \\ 8 \\ 11 \end{gathered}$ | $\begin{aligned} & 10 \\ & 11 \\ & 14 \end{aligned}$ |  | dB |
| Gain 1 dB Compression Output Power | $\mathrm{Po}(1 \mathrm{~dB})$ | $\begin{aligned} & \mathrm{f}=0.9 \mathrm{GHz} \\ & \mathrm{f}=1.9 \mathrm{GHz} \\ & \mathrm{f}=2.4 \mathrm{GHz} \end{aligned}$ | $\begin{aligned} & +7.0 \\ & +6.5 \\ & +5.5 \end{aligned}$ | $\begin{aligned} & +9.5 \\ & +9.0 \\ & +8.0 \end{aligned}$ |  | dBm |
| Saturated Output Power | Po (sat) | $\begin{aligned} & \mathrm{f}=0.9 \mathrm{GHz}, P_{\mathrm{in}}=-5 \mathrm{dBm} \\ & \mathrm{f}=1.9 \mathrm{GHz}, P_{\mathrm{in}}=-5 \mathrm{dBm} \\ & \mathrm{f}=2.4 \mathrm{GHz}, P_{\mathrm{in}}=-5 \mathrm{dBm} \end{aligned}$ |  | $\begin{aligned} & +11.0 \\ & +10.5 \\ & +10.0 \end{aligned}$ |  | dBm |

## TEST CIRCUITS



COMPONENTS OF TEST CIRCUIT
EXAMPLE OF ACTUAL APPLICATION COMPONENTS FOR MEASURING ELECTRICAL
CHARACTERISTICS

|  | Type | Value |
| :---: | :---: | :---: |
| $\mathrm{C}_{1}, \mathrm{C}_{2}$ | Bias Tee | 1000 pF |
| $\mathrm{C}_{3}$ | Capacitor | 1000 pF |
| L | Bias Tee | 1000 nH |


|  | Type | Value | Operating Frequency |
| :---: | :---: | :---: | :---: |
| $\mathrm{C}_{1}$ to $\mathrm{C}_{3}$ | Chip capacitor | 1000 pF | 100 MHz or higher |
| L | Chip inductor | 100 nH | 100 MHz or higher |
|  |  | 10 nH | 2.0 GHz or higher |

## INDUCTOR FOR THE OUTPUT PIN

The internal output transistor of this IC consumes 20 mA , to output medium power. To supply current for output transistor, connect an inductor between the Vcc pin (pin 6) and output pin (pin 4). Select large value inductance, as listed above.

The inductor has both DC and AC effects. In terms of DC, the inductor biases the output transistor with minimum voltage drop to output enable high level. In terms of AC, the inductor makes output-port-impedance higher to get enough gain. In this case, large inductance and Q is suitable.

For above reason, select an inductance of $100 \Omega$ or over impedance in the operating frequency. The gain is a peak in the operating frequency band, and suppressed at lower frequencies.

The recommendable inductance can be chosen from example of actual application components list as shown above.

## CAPACITORS FOR THE VCC, INPUT, AND OUTPUT PINS

Capacitors of 1000 pF are recommendable as the bypass capacitor for the Vcc pin and the coupling capacitors for the input and output pins.

The bypass capacitor connected to the Vcc pin is used to minimize ground impedance of Vcc pin. So, stable bias can be supplied against Vcc fluctuation.

The coupling capacitors, connected to the input and output pins, are used to cut the DC and minimize RF serial impedance. Their capacitance are therefore selected as lower impedance against a $50 \Omega$ load. The capacitors thus perform as high pass filters, suppressing low frequencies to DC.

To obtain a flat gain from 100 MHz upwards, 1000 pF capacitors are used in the test circuit. In the case of under 10 MHz operation, increase the value of coupling capacitor such as 10000 pF . Because the coupling capacitors are determined by equation, $C=1 /(2 \pi R f c)$.

## ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



COMPONENT LIST

|  | Value |
| :---: | :---: |
| C | 1000 pF |
| L | Example: 10 nH |

TYPICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified)

CIRCUIT CURRENT vs. SUPPLY VOLTAGE


NOISE FIGURE, POWER GAIN vs. FREQUENCY


ISOLATION vs. FREQUENCY


CIRCUIT CURRENT vs. OPERATING AMBIENT TEMPERATURE


POWER GAIN vs. FREQUENCY


INPUT RETURN LOSS, OUTPUT RETURN LOSS vs. FREQUENCY


OUTPUT POWER vs. INPUT POWER


OUTPUT POWER vs. INPUT POWER


OUTPUT POWER vs. INPUT POWER


OUTPUT POWER vs. INPUT POWER


OUTPUT POWER vs. INPUT POWER


OUTPUT POWER vs. INPUT POWER



3RD ORDER INTERMODULATION DISTORTION © vs. OUTPUT POWER OF EACH TONE


3RD ORDER INTERMODULATION DISTORTION


3RD ORDER INTERMODULATION DISTORTION



Remark The graphs indicate nominal characteristics.

## SMITH CHART (Vcc = Vout = 3.0 V)

## S11-FREQUENCY



S22-FREQUENCY


## * S-PARAMETERS

S-parameters/Noise parameters are provided on the NEC Compound Semiconductor Devices Web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

Click here to download S-parameters.
[RF and Microwave] $\rightarrow$ [Device Parameters]
URL http://www.csd-nec.com/

## PACKAGE DIMENSIONS

6-PIN SUPER MINIMOLD (UNIT: mm)


## NOTES ON CORRECT USE

(1) Observe precautions for handling because of electro-static sensitive devices.
(2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground pins must be connected together with wide ground pattern to decrease impedance difference.
(3) The bypass capacitor should be attached to the Vcc pin.
(4) The inductor must be attached between Vcc and output pins. The inductance value should be determined in accordance with desired frequency.
(5) The DC cut capacitor must be attached to input and output pin.

## RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method |  | Soldering Conditions |  |
| :--- | :--- | :--- | :--- |
| Infrared Reflow | Peak temperature (package surface temperature) | $: 260^{\circ} \mathrm{C}$ or below | Condition Symbol |
|  | Time at peak temperature | $: 10$ seconds or less |  |
|  | Time at temperature of $220^{\circ} \mathrm{C}$ or higher | $: 60$ seconds or less |  |
|  | Preheating time at 120 to $180^{\circ} \mathrm{C}$ | $: 120 \pm 30$ seconds |  |
|  | Maximum number of reflow processes | $: 3$ times | $: 0.2 \%$ (Wt.) or below |

Caution Do not use different soldering methods together (except for partial heating).

## Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix -A indicates that the device is Pb -free. The -AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

| Restricted Substance <br> per RoHS | Concentration Limit per RoHS <br> (values are not yet fixed) | Concentration contained <br> in CEL devices |  |
| :--- | :---: | :---: | :---: |
| Lead $(\mathrm{Pb})$ | $<1000$ PPM | -A | -AZ |
| Mercury | $<1000$ PPM | Not Detected | (*) |
| Cadmium | $<100$ PPM | Not Detected |  |
| Hexavalent Chromium | $<1000$ PPM | Not Detected |  |
| PBB | $<1000$ PPM | Not Detected |  |
| PBDE | $<1000$ PPM | Not Detected |  |

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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